

DATA SHEET

AX521

Analog Input/Output Module



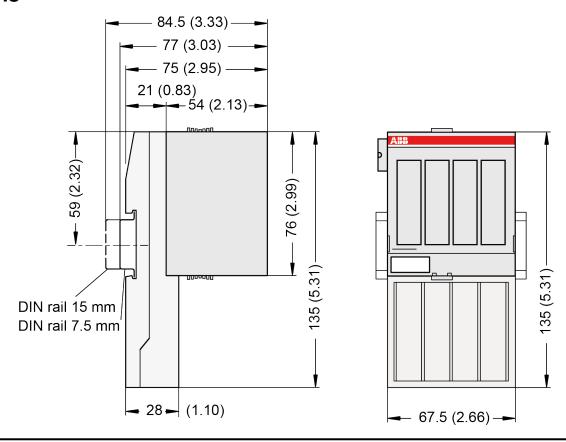
1 Ordering Data

Part no.	Description	Product life cycle phase *)
	AX521, analog input/output module, 4 AI, 4 AO, U/I/Pt100, 12 bits + sign, 2-wires	Active
1SAP 450 100 R0001	AX521-XC, analog input/output module, 4 AI, 4 AO, U/I/Pt100, 12 bits + sign, 2-wires, XC version	Active



*) Modules in lifecycle Classic are available from stock but not recommended for planning and commissioning of new installations.

2 Dimensions





The dimensions are in mm and in brackets in inch.

3 Technical data

The system data of AC500 and S500 \mathsepsilon Chapter 4 "System data AC500" on page 5 are valid for standard version.

The system data of AC500-XC & Chapter 5 "System data AC500-XC" on page 9 are valid for the XC version.

Only additional details are therefore documented below.

The technical data are also valid for the XC version.

Parame	ter	Value
Process	voltage	
	Connections	Terminals 1.8, 2.8, 3.8 and 4.8 for +24 V (UP) as well as 1.9, 2.9, 3.9 and 4.9 for 0 V (ZP)
	Rated value	24 VDC
	Max. ripple	5 %
	Protection against reversed voltage	Yes
	Rated protection fuse on UP	10 A fast

Parameter		Value
	Galvanic isolation	Yes, per module
Current	consumption	
	From 24 VDC power supply at the terminals UP/L+ and ZP/M of the CPU/bus module	Ca. 2 mA
	From UP at normal operation	0.15 A + output loads
Inrush o	current from UP (at power up)	0.020 A ² s
Max. length of analog cables, conductor cross section > 0.14 mm²		100 m
Weight		300 g
Mounting position		Horizontal or vertical with derating (output load reduced to 50 % at 40 °C per group)
Cooling		The natural convection cooling must not be hindered by cable ducts or other parts in the switch-gear cabinet.



NOTICE!

Attention:

All I/O channels (digital and analog) are protected against reverse polarity, reverse supply, short circuit and continuous overvoltage up to 30 VDC.

3.1 Technical data of the analog inputs

Parameter	Value
Number of channels per module	4
Distribution of channels into groups	1 group of 4 channels
Connections of the channels I0- to I3-	Terminals 1.0 to 1.3
Connections of the channels I0+ to I3+	Terminals 2.0 to 2.3
Input type	Bipolar (not with current or Pt100/Pt1000/Ni1000)
Galvanic isolation	Against internal supply and other modules
Configurability	0 V10 V, -10 V+10 V, 0 mA20 mA, 4 mA20 mA, Pt100/1000, Ni1000 (each input can be configured individually)
Channel input resistance	Voltage: > 100 kΩ
	Current: ca. 330 Ω
Time constant of the input filter	Voltage: 100 μs
	Current: 100 μs
Indication of the input signals	One LED per channel
Conversion cycle	2 ms (for 8 inputs + 8 outputs), with Pt/Ni 1 s
Resolution	Range 0 V10 V: 12 bits
	Range -10 V+10 V: 12 bits + sign
	Range 0 mA20 mA: 12 bits
	Range 4 mA20 mA: 12 bits

Parameter	Value	
Conversion error of the analog values caused by non-linearity, adjustment error at factory and resolution within the	Тур.	±0.5 % of full scale at 25 °C
normal range	Max.	±1 % of full scale (all ranges)
		at 0 °C60 °C or EMC disturbance
Relationship between input signal and hex code	See tables	
Unused voltage inputs	Are configured as "unused"	
Unused current inputs	Have a low resistance, can be left open-circuited	
Overvoltage protection	Yes	

3.2 Technical data of the analog inputs, if used as digital inputs

Par	ameter	Value
Number of channels per module		Max. 4
	ribution of channels into groups	1 group of 4 channels
	nections of the channels I0+ to I3+	Terminals 2.0 to 2.3
	erence potential for the inputs	Terminals 2.0 to 2.0 Terminals 1.9, 2.9, 3.9 and 4.9 (ZP)
	<u> </u>	
Inpu	ut signal delay	Typ. 8 ms, configurable from 0.1 to 32 ms
Indi	cation of the input signals	1 LED per channel
Inpu	ıt signal voltage	24 VDC
	Signal 0	-30 V+5 V
	Undefined signal	+5 V+13 V
	Signal 1	+13 V+30 V
Inpu	ut current per channel	
	Input voltage +24 V	Typ. 7 mA
	Input voltage +5 V	Typ. 1.4 mA
	Input voltage +15 V	Typ. 4.3 mA
	Input voltage +30 V	< 9 mA
Input resistance		ca. 3.5 kΩ

3.3 Technical data of the analog outputs

Parameter		Value	
Number of channels per module		4, all channels for voltage and current	
Di	stribution of channels into groups	1 group of 4 channels	
	Channels 0003-	Terminals 3.03.3	
	Channels O0+O3+	Terminals 4.04.3	
Output type		Bipolar with voltage, unipolar with current	
Galvanic isolation		Against internal supply and other modules	

Parameter	Value		
Configurability	-10 V+10 V, 0 mA20 mA, 4 mA20 mA (each output can be configured individually), current outputs only channels 03		
Output resistance (load), as current output	0 Ω500 Ω		
Output loadability, as voltage output	Max. ±1	0 mA	
Indication of the output signals	One LE	D per channel	
Resolution	12 bits (12 bits (+ sign)	
Settling time for full range change (resistive load, output signal within specified tolerance)	Typ. 5 ms		
Conversion error of the analog values	Тур.	±0.5 % of full scale	
caused by non-linearity, adjustment error at factory and resolution within the normal		at 25 °C	
range	Max.	±1 % of full scale (all ranges)	
		at 0 °C60 °C or EMC disturbance	
Relationship between output signal and hex code	See table		
Unused outputs	Can be left open-circuited		

4 System data AC500

4.1 Environmental conditions

Table 1: Process and supply voltages

Par	ameter	Value	
24	VDC		
	Voltage	24 V (-15 %, +20 %)	
	Max. ripple	5 % from nominal value	
	Protection against reverse polarity	Yes	
120	VAC		
	Voltage	120 V (-15 %, +10 %)	
	Frequency	50/60 Hz (-6 %, +4 %)	
230	VAC		
	Voltage	230 VAC (-15 %, +10 %)	
	Frequency	50/60 Hz (-6 %, +4 %)	
120	VAC240 VAC wide range supply		
	Voltage	120 V240 V (-15 %, +10 %)	
	Frequency	50/60 Hz (-6 %, +4 %)	
Allo	Allowed interruptions of power supply, according to EN 61131-2		
	DC supply	Interruption < 10 ms, time between 2 interruptions > 1 s, PS2	
	AC supply	Interruption < 0.5 periods, time between 2 interruptions > 1 s	



NOTICE!

Exceeding the maximum power supply voltage for process or supply voltages could lead to unrecoverable damage of the system. The system could be destroyed.



NOTICE!

Improper voltage level or frequency range which cause damage of AC inputs:

- AC voltage above 264 V
- Frenquency below 47 Hz or above 62.4 Hz



NOTICE!

Improper connection leads cause overtemperature on terminals.

PLC modules may be destroyed by using wrong cable type, wire size and cable temperature classification.

Parameter		Value
Tem	perature	
	Operating	0 °C+60 °C: Horizontal mounting of modules.
		0 °C+40 °C: Vertical mounting of modules. Output load reduced to 50 % per group.
	Storage	-40 °C+70 °C
	Transport	-40 °C+70 °C
Hun	nidity	Max. 95 %, without condensation
Air	pressure	
	Operating	> 800 hPa / < 2000 m
	Storage	> 660 hPa / < 3500 m
Ingr	ess protection	IP20

4.2 Creepage distances and clearances

The creepage distances and clearances meet the requirements of the overvoltage category II, pollution degree 2.

4.3 Insulation test voltages, routine test

According to EN 61131-2

Parameter	Value	
230 V circuits against other circuitry	2500 V	1.2/50 μs
120 V circuits against other circuitry	1500 V	1.2/50 μs
120 V240 V circuits against other circuitry	2500 V	1.2/50 μs

Parameter	Value	
24 V circuits (supply, 24 V inputs/outputs, analogue inputs/outputs), if they are electrically isolated against other circuitry	500 V	1.2/50 μs
COM interfaces, electrically isolated	500 V	1.2/50 μs
COM interfaces, electrically not isolated	Not applicable	Not applicable
FBP interface	500 V	1.2/50 μs
Ethernet	500 V	1.2/50 μs
ARCNET	500 V	1.2/50 μs
230 V circuits against other circuitry	1350 V	AC 2 s
120 V circuits against other circuitry	820 V	AC 2 s
120 V240 V circuits against other circuitry	1350 V	AC 2 s
24 V circuits (supply, 24 V inputs/outputs, analogue inputs/outputs), if they are electrically isolated against other circuitry	350 V	AC 2 s
COM interfaces, electrically isolated	350 V	AC 2 s
COM interfaces, electrically not isolated	Not applicable	Not applicable
FBP interface	350 V	AC 2 s
Ethernet	350 V	AC 2 s
ARCNET	350 V	AC 2 s

4.4 Power supply units

For the supply of the modules, power supply units according to PELV specifications must be used.

4.5 Electromagnetic compatibility

Table 2: Range of use

Parameter	Value
Industrial applications	Yes
Domestic applications	No

Table 3: Immunity against electrostatic discharge (ESD), according to IEC 61000-4-2, zone B, criterion B

Parameter	Value
Electrostatic voltage in case of air discharge	8 kV
Electrostatic voltage in case of contact discharge	4 kV, in a closed switch-gear cabinet 6 kV ¹)
ESD with communication connectors	In order to prevent operating malfunctions, it is recommended, that the operating personnel discharge themselves prior to touching communication connectors or perform other suitable measures to reduce effects of electrostatic discharges.
ESD with connectors of terminal bases	The connectors between the Terminal Bases and Processor Modules or Communication Modules must not be touched during operation. The same is valid for the I/O-Bus with all modules involved.

¹) High requirement for shipping classes are achieved with additional specific measures (see specific documentation).

Table 4: Immunity against the influence of radiated (CW radiated), according to IEC 61000-4-3, zone B, criterion A

Parameter	Value
Test field strength	10 V/m

Table 5: Immunity against fast transient interference voltages (burst), according to IEC 61000-4-4, zone B, criterion B

Parameter	Value
Supply voltage units (DC)	2 kV
Supply voltage units (AC)	2 kV
Digital inputs/outputs (24 VDC)	1 kV
Digital inputs/outputs (120 VAC240 VAC)	2 kV
Analog inputs/outputs	1 kV
CS31 system bus	1 kV
Serial RS-485 interfaces (COM)	1 kV
Serial RS-232 interfaces (COM, not for PM55x and PM56x)	1 kV
ARCNET	1 kV
FBP	1 kV
Ethernet	1 kV
I/O supply (DC-out)	1 kV

Table 6: Immunity against the influence of line-conducted interferences (CW conducted), according to IEC 61000-4-6, zone B, criterion A

Parameter		Value
Test voltage		3V zone B, 10 V is also met.
Hig	h energy surges	According to IEC 61000-4-5, zone B, criterion B
	Power supply DC	1 kV CM / 0.5 kV DM ²)
	DC I/O supply	0.5 kV CM / 0.5 kV DM ²)

Parameter		Value
	Communication Lines, shielded	1 kV CM ²)
	AC I/O unshielded ³)	2 kV CM / 1 kV DM ²)
	I/O analog, I/O DC unshielded ³)	1 kV CM / 0.5 kV DM ²)
Radiation (radio disturbance)		According to IEC 55011, group 1, class A

²) CM = Common Mode, DM = Differential Mode

4.6 Mechanical data

Parameter	Value	
Mounting	Horizontal	
Degree of protection	IP 20	
Housing	Classification V-2 according to UL 94	
Vibration resistance acc. to EN 61131-2	all three axes	
	2 Hz8.4 Hz, continuous 3.5 mm	
	8.4 Hz150 Hz, continuous 1 g (higher values on request)	
Shock test	All three axes	
	15 g, 11 ms, half-sinusoidal	
Mounting of the modules:		
DIN rail according to DIN EN 50022	35 mm, depth 7.5 mm or 15 mm	
Mounting with screws	Screws with a diameter of 4 mm	
Fastening torque	1.2 Nm	

4.7 Approvals and certifications

Information on approvals and certificates can be found in the corresponding chapter of the *Main catalog, PLC Automation*.

5 System data AC500-XC

nt AC500-XC is iden-
nformation on genera

 $^{^3}$) When DC I/O inputs are used with AC voltage, external filters limiting high energy surges to 1 kV CM / 0.5 DM are required to meet requirements according IEC 61131-2.

5.1 Environmental conditions

Table 7: Process and supply voltages

Par	ameter	Value	
24 VDC			
	Voltage	24 V (-15 %, +20 %)	
	Protection against reverse polarity	Yes	
120 VAC240 VAC wide range supply			
	Voltage	120240 V (-15 %, +10 %)	
	Frequency	50/60 Hz (-6 %, +4 %)	
Allowed interruptions of power supply			
	DC supply	Interruption < 10 ms, time between 2 interruptions > 1 s, PS2	



NOTICE!

Exceeding the maximum power supply voltage for process or supply voltages could lead to unrecoverable damage of the system. The system could be destroyed.



NOTICE!

For the supply of the modules, power supply units according to PELV or SELV specifications must be used.



The creepage distances and clearances meet the requirements of the overvoltage category II, pollution degree 2.

Parameter		Value
Temp	perature	
	Operating	-40 °C+70 °C
		-40 °C30 °C: Proper start-up of system; technical data not guaranteed
		-40 °C0 °C: Due to the LCD technology, the display might respond very slowly.
		-40 °C+40 °C: Vertical mounting of modules possible, output load limited to 50 % per group
		+60 °C+70 °C with the following deratings:
		 System is limited to max. 2 communication modules per terminal base Applications certified for cULus up to +60 °C Digital inputs: maximum number of simultaneously switched on input channels limited to 75 % per group (e.g. 8 channels => 6 channels) Digital outputs: output current maximum value (all channels together) limited to 75 % per group (e.g. 8 A => 6 A) Analog outputs only if configured as voltage output: maximum total output current per group is limited to 75 % (e.g. 40 mA => 30 mA) Analog outputs only if configured as current output: maximum number of simultaneously used output channels limited to 75 % per group (e.g. 4 channels => 3 channels)
	Storage / Transport	-40 °C+85 °C
Hum	idity	Operating / Storage: 100 % r. H. with condensation
Air p	ressure	Operating:
		-1000 m4000 m (1080 hPa620 hPa)
		> 2000 m (< 795 hPa):
		 max. operating temperature must be reduced by 10 K (e.g. 70 °C to 60°C) I/O module relay contacts must be operated
		with 24 V nominal only
Immunity to corrosive gases		Operating: Yes, according to:
		ISA S71.04.1985 Harsh group A, G3/GX
		IEC 60721-3-3 3C2 / 3C3
Immi	unity to salt mist	Operating: Yes, horizontal mounting only, according to IEC 60068-2-52 severity level: 1



NOTICE!

Risk of corrosion!

Unused connectors and slots may corrode if XC devices are used in salt-mist environments.

Protect unused connectors and slots with TA535 protective caps for XC devices.

Table 8: Electromagnetic compatibility

Parameter	Value
Device suitable for:	
Industrial applications	Yes
Domestic applications	No
Radiated emission (radio disturbances)	Yes, according to:
	CISPR 16-2-3
Conducted emission (radio disturbances)	Yes, according to:
	CISPR 16-2-1, CISPR 16-1-2
Electrostatic discharge (ESD)	Yes, according to:
	IEC 61000-4-2, zone B, criterion B
Fast transient interference voltages (burst)	Yes, according to:
	IEC 61000-4-4, zone B, criterion B
High energy transient interference voltages (surge)	Yes, according to:
	IEC 61000-4-5, zone B, criterion B
Influence of radiated disturbances	Yes, according to:
	IEC 61000-4-3, zone B, criterion A
Influence of line-conducted interferences	Yes, according to:
	IEC 61000-4-6, zone B, criterion A
Influence of power frequency magnetic fields	Yes, according to:
	IEC 61000-4-8, zone B, criterion A



In order to prevent malfunctions, it is recommended, that the operating personnel discharge themselves prior to touching communication connectors or perform other suitable measures to reduce effects of electrostatic discharges.



NOTICE!

Risk of malfunctions!

Unused slots for communication modules are not protected against accidental physical contact.

- Unused slots for communication modules must be covered with dummy communication modules () to achieve IP20 rating.
- I/O bus connectors must not be touched during operation.

5.2 Mechanical data

Parameter	Value	
Wiring method	Spring terminals	
Degree of protection	IP 20	
Vibration resistance	Yes, according to:	
	IEC 61131-2	
	IEC 60068-2-6	
	IEC 60068-2-64	
Shock resistance	Yes, according to:	
	IEC 60068-2-27	
Assembly position	Horizontal	
	Vertical (no application in salt mist environment)	
Assembly on DIN rail		
DIN rail type	According to IEC 60715	
	35 mm, depth 7.5 mm or 15 mm	
Assembly with screws		
Screw diameter	4 mm	
Fastening torque	1.2 Nm	

5.3 Environmental tests

Parameter	Value
Storage	IEC 60068-2-1 Test Ab: cold withstand test -40 °C / 16 h
	IEC 60068-2-2 Test Bb: dry heat withstand test +85 °C / 16 h
Humidity	IEC 60068-2-30 Test Db: Cyclic (12 h / 12 h) damp-heat test 55 °C, 93 % r. H. / 25 °C, 95 % r. H., 6 cycles
	IEC 60068-2-78, stationary humidity test: 40 °C, 93 % r. H., 240 h
Insulation Test	IEC 61131-2
Vibration resistance	IEC 61131-2 / IEC 60068-26: 5 Hz500 Hz, 2 g (with SD memory card inserted)
	IEC 60068-2-64: 5 Hz500 Hz, 4 g rms
Shock resistance	IEC 60068-2-27: all 3 axes 15 g, 11 ms, half-sinusoidal

Table 9: EMC immunity

Parameter	Value
Electrostatic discharge (ESD)	Electrostatic voltage in case of air discharge: 8 kV
	Electrostatic voltage in case of contact discharge: 6 kV
Fast transient interference voltages (burst)	Supply voltage units (DC): 4 kV
	Digital inputs/outputs (24 VDC): 2 kV
	Analog inputs/outputs: 2 kV
	Communication lines shielded: 2 kV
	I/O supply (DC-out): 2 kV

Parameter	Value
High energy transient interference voltages (surge)	Supply voltage units (DC): 1 kV CM *) / 0.5 kV DM *)
	Digital inputs/outputs (24 VDC): 1 kV CM *) / 0.5 kV DM *)
	Digital inputs/outputs (AC): 4 kV
	Analog inputs/outputs: 1 kV CM *) / 0.5 kV DM *)
	Communication lines shielded: 1 kV CM)*
	I/O supply (DC-out): 0,5 kV CM *) / 0.5 kV DM *)
Influence of radiated disturbances	Test field strength: 10 V/m
Influence of line-conducted interferences	Test voltage: 10 V
Power frequency magnetic fields	30 A/m 50 Hz
	30 A/m 60 Hz

^{*)} CM = Common Mode, * DM = Differential Mode

abb.com/plc

We reserve all rights in this document and in the information contained therein. Reproduction, use or disclosure to third parties without express authority is strictly forbidden.

ABB Automation Products GmbH Eppelheimer Str. 82 69123 Heidelberg, Germany Telephone: +49 (0)6221 701 1444 Fax: +49 (0)6221 701 1382 E-mail: plc.support@de.abb.com